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Vishay Semiconductors

Insulated Gate Bipolar Transistor (Warp 2 Speed IGBT), 100 A



SOT-227

PRODUCT SUMMARY						
V _{CES}	600 V					
I _C DC	100 A at 61 °C					
V _{CE(on)} typical at 100 A, 25 °C	2.4 V					
I _F DC	100 A at 85 °C					
Package	SOT-227					
Circuit	Single Switch Diode					

FEATURES

 NPT warp 2 speed IGBT technology with positive temperature coefficient



Square RBSOA

- HEXFRED[®] antiparallel diodes with ultrasoft reverse recovery
- · Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- · Industry standard outline
- UL approved file E78996



· Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- · Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Higher switching frequency up to 150 kHz
- Lower conduction losses and switching losses
- · Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
		T _C = 25 °C	125		
Continuous collector current	I _C	T _C = 80 °C	85		
Pulsed collector current	I _{CM}		300		
Clamped inductive load current	I _{LM}		300	А	
Diode continuous forward current		T _C = 25 °C	160		
	I _F	T _C = 80 °C	105		
Peak diode forward current	I _{FM}		200		
Gate to emitter voltage	V _{GE}		± 20	V	
Power dissipation, IGBT		T _C = 25 °C	447		
	P _D	T _C = 80 °C	250	147	
Power dissipation, diode	Б	T _C = 25 °C	313	W	
	P _D	T _C = 80 °C	175		
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V	



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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	V _{GE} = 0 V, I _C = 250 μA	600	-	-		
Collector to emitter voltage	V	V _{GE} = 15 V, I _C = 100 A	-	2.4	2.8	V	
Collector to emitter voltage V _{CE(on)}		V _{GE} = 15 V, I _C = 100 A, T _J = 125 °C	-	3	3.4		
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}, I_{C} = 250 \ \mu A$	3	3.9	5		
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)}/\Delta T_{J}$	V _{CE} = V _{GE} , I _C = 1 mA (25 °C to 125 °C)	-	-10	-	mV/°C	
Collector to emitter leakage current		V _{GE} = 0 V, V _{CE} = 600 V	-	7	100	μΑ	
Collector to emitter leakage current	I _{CES}	V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150 °C	-	4	10	mA	
Conveyed veltage dyes	V _{FM}	I _C = 100 A, V _{GE} = 0 V	-	1.6	2.1	V	
Forward voltage drop		I _C = 100 A, V _{GE} = 0 V, T _J = 125 °C	-	1.7	2	V	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA	

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Q_g			-	460	690	
Gate to emitter charge (turn-on)	Q _{ge}	$I_C = 100 \text{ A}, V_{CC} = 480 \text{ V},$	V _{GE} = 15 V	-	160	250	nC
Gate to collector charge (turn-on)	Q_{gc}			-	70	130	
Turn-on switching loss	E _{on}	I _C = 100 A, V _{CC} = 360 V,		-	0.36	=	
Turn-off switching loss	E _{off}	V_{GE} = 15 V, R_g = 5 Ω ,		-	1.42	-	mJ
Total switching loss	E _{tot}	$L = 500 \mu H, T_J = 25 °C$		-	1.78	-	
Turn-on switching loss	E _{on}		Energy losses include tail and diode recovery (see fig. 18)	-	0.52	-	
Turn-off switching loss	E _{off}			-	1.6	-	
Total switching loss	E _{tot}	$I_{C} = 100 \text{ A}, V_{CC} = 360 \text{ V},$ $V_{GE} = 15 \text{ V}, R_{g} = 5 \Omega,$ $L = 500 \ \mu\text{H}, T_{J} = 125 \ ^{\circ}\text{C}$		-	2.12	-	
Turn-on delay time	t _{d(on)}			-	264	-	- ns
Rise time	t _r			-	54	-	
Turn-off delay time	t _{d(off)}			-	257	-	
Fall time	t _f			-	80	-	
Reverse bias safe operating area	RBSOA	T_J = 150 °C, I_C = 300 A, R_g = 22 Ω , V_{GE} = 15 V to 0 V, V_{CC} = 400 V, V_P = 600 V, L = 500 μH			Fullsquare		
Diode reverse recovery time	t _{rr}			-	95	120	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _R = 200 V			10	13	Α
Diode recovery charge	Q _{rr}				480	780	nC
Diode reverse recovery time	t _{rr}	$I_F = 50 \text{ A, } dI_F/dt = 200 \text{ A/}\mu\text{s,}$ $V_R = 200 \text{ V, } T_J = 125 ^{\circ}\text{C}$		-	144	185	ns
Diode peak reverse current	I _{rr}			-	16	19	Α
Diode recovery charge	Q _{rr}			-	1136	1758	nC

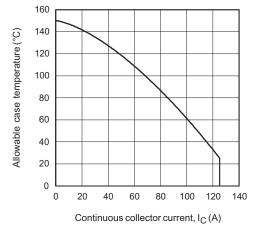


Case style

VS-GB100DA60UP

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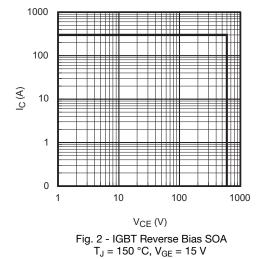
THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL		MIN.	TYP.	MAX.	UNITS
Junction and storage temperature	range	T _J , T _{Stg}		-40	-	150	°C
Junction to case	IGBT	D		-	-	0.28	
Junction to case	Diode	R _{thJC}		-	-	0.4	°C/W
Case to heatsink		R _{thCS}	Flat, greased surface	-	0.05	-	
Weight				-	30	-	g
Mounting torque				-	-	1.3	Nm

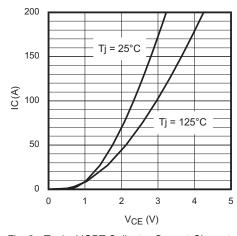


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Fig. 1 - Maximum DC IGBT Collector Current vs.

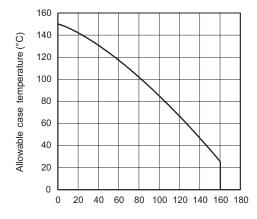
Case Temperature





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Fig. 3 - Typical IGBT Collector Current Characteristics



 $\label{eq:continuous forward current, IF} \mbox{ Caninuous forward current, IF} (A) \\ \mbox{Fig. 4 - Maximum DC Forward Current vs.} \\ \mbox{ Case Temperature} \\$



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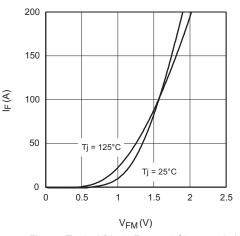


Fig. 5 - Typical Diode Forward Characteristics

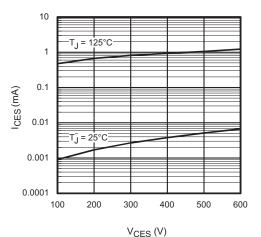


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

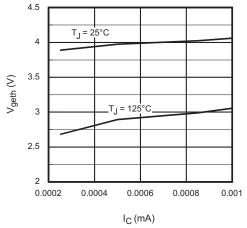


Fig. 7 - Typical IGBT Threshold Voltage

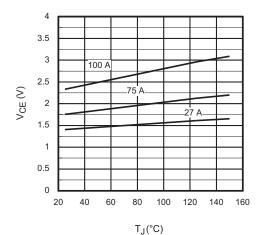


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature, $V_{GE} = 15 \text{ V}$

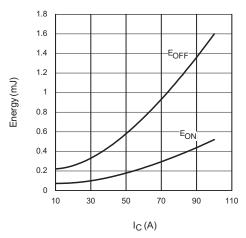


Fig. 9 - Typical IGBT Energy Loss vs. I_C T_J = 125 °C, L = 500 μ H, V_{CC} = 360 V, R_g = 5 Ω , V_{GE} = 15 V

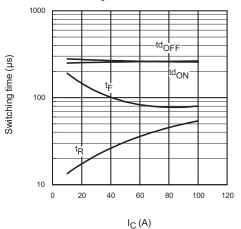


Fig. 10 - Typical IGBT Switching Time vs. I_C T_J = 125 °C, L = 500 μ H, V_{CC} = 360 V, R_g = 5 Ω , V_{GE} = 15 V



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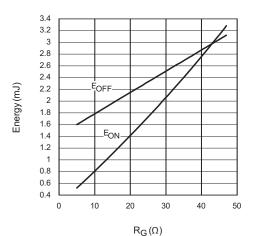


Fig. 11 - Typical IGBT Energy Loss vs. R_g T_J = 125 °C, I_C = 100 A, L = 500 μ H, V_{CC} = 360 V, V_{GE} = 15 V

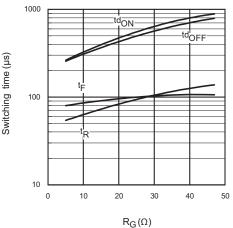


Fig. 12 - Typical IGBT Switching Time vs. R_g T_J = 125 °C, L = 500 μ H, V_{CC} = 360 V, I_C = 100 A, V_{GE} = 15 V

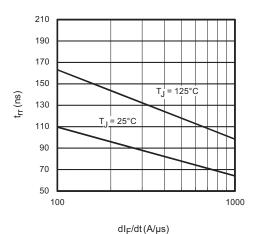


Fig. 13 - Typical t_{rr} diode vs. dI_F/dt $V_{RR} = 200 \text{ V}, I_F = 50 \text{ A}$

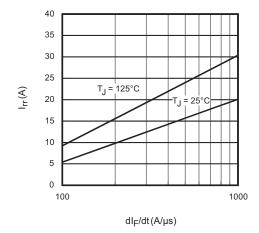


Fig. 14 - Typical I_{rr} diode vs. dI_F/dt $V_{RR} = 200 \text{ V}, I_F = 50 \text{ A}$

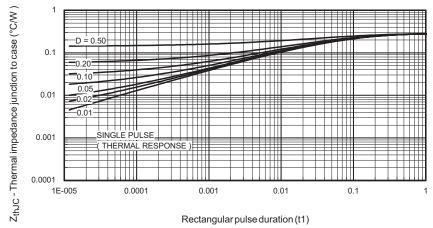


Fig. 15 - Maximum Thermal Impedance Z_{thJC} Characteristics (IGBT)



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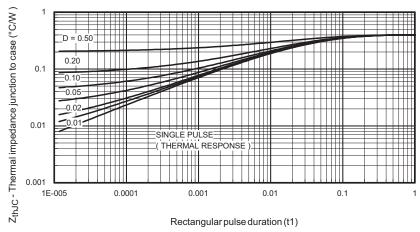
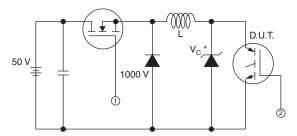


Fig. 16 - Maximum Thermal Impedance Z_{thJC} Characteristics (diode)



- * Driver same type as D.U.T.; V $_{\rm C}$ = 80 % of V $_{\rm ce(max)}$ * Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id

Fig. 17a - Clamped Inductive Load Test Circuit

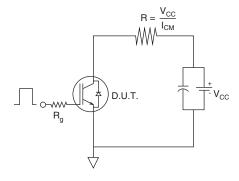


Fig. 17b - Pulsed Collector Current Test Circuit

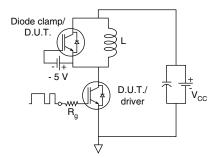


Fig. 18a - Switching Loss Test Circuit

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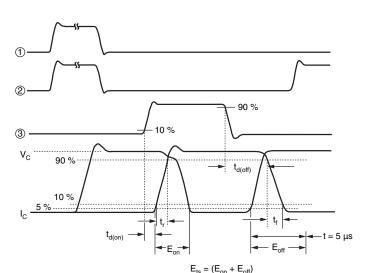
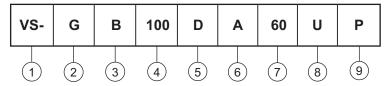


Fig. 18b - Switching Loss Waveforms Test Circuit

ORDERING INFORMATION TABLE

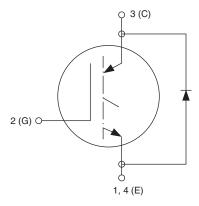
Device code

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- 1 Vishay Semiconductors product
- 2 Insulated Gate Bipolar Transistor (IGBT)
- 3 B = IGBT Generation 5
- 4 Current rating (100 = 100 A)
- 5 Circuit configuration (D = Single switch with antiparallel diode)
- 6 Package indicator (A = SOT-227)
- 7 Voltage rating (60 = 600 V)
- Speed/type (U = Ultrafast IGBT)
- 9 Totally lead (Pb)-free

CIRCUIT CONFIGURATION



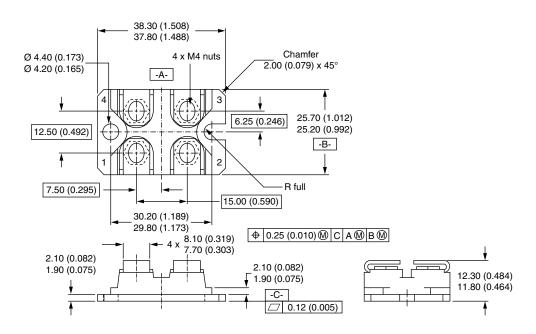
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95036</u>					
Packaging information	www.vishay.com/doc?95037				



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DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- · Controlling dimension: millimeter

Document Number: 95036 Revision: 28-Aug-07



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